



ERNEST F. CHAPMAN 202-408-4096

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ATTORNEY DOCKET NO. 08244.0032 CUSTOMER NO. 22,852



Box PATENT APPLICATION Assistant Commissioner for Patents Washington, DC 20231

New U.S. Patent Application

Title: METHOD FOR FORMING CONTACT HOLE AND SPACER OF SEMICONDUCTOR DEVICE

Inventors Names and Residences:

- 1. Sung-Chan PARK, Kyoungki-do, Korea;
- 2. Phil-Goo KONG, Kyoungki-do, Korea; and
- 3. Kuk-Han YOON, Kyoungki-do, Korea.

Sir:

We enclose the following papers for filing in the United States Patent and Trademark Office in connection with the above patent application.

- 1. Application- 19 pages, including 2 independent claims and 20 claims total.
- 2. Drawings- 14 sheets of acceptable drawings containing 25 figures.
- 3. Certified copy of Korean Application No. 2000-75286, filed December 11, 2000.
- 4. The filing fee is calculated as follows:

Basic Application Filing Fee					\$740	\$	\$740.00
	Number of Claims		Basic	Extra Claims			
Total Claims	20	-	20	0	x \$18		
Independent Claims	2	-	3	0	x \$84		
☐ Presentation of Multiple Dep. Claim(s) +\$280							
Subtotal						\$	740.00
Reduction by 1/2 if small entity						-	
TOTAL APPLICATION FILING FEE						\$	740.00

A check for \$740.00 is enclosed for the filing fee.

This application is being filed under the provisions of 37 C.F.R. § 1.53(f). Applicants await notification from the Patent and Trademark Office of the time set for filing the Declaration.

Applicants claim the right to priority based on Korean Application No. 2000-75286, filed December 11, 2000.

Please address all correspondence with respect to this application to:

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Please accord this application an application number and filing date.

The Commissioner is hereby authorized to charge any additional filing fees due and any other fees due under 37 C.F.R. § 1.16 or §1.17 during the pendency of this application to our Deposit Account No. 06-0916.

Respectfully submitted, FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Ernest F. Chapman

Reg. No. 25,961

EFC/FPD/peg Enclosures